

#### DESCRIPTION

The IS280GR single channel and IS280-4GR quad channel optocouplers each channel consist of two infrared emitting diodes in reverse parallel connection optically coupled to an NPN silicon photo transistor.

These devices belong to Isocom Compact Range of Optocouplers.

#### **FEATURES**

- Half Pitch 1.27mm
- High AC Isolation voltage 3750V<sub>RMS</sub>
- Wide Operating Temperature Range -55°C to 110°C
- Pb Free and RoHS Compliant
- UL Approval E91231 Model "AHP"

#### **APPLICATIONS**

- Hybrid Substrates with High Density Mounting
- Industrial System Controllers
- Measuring Instruments
- System Appliances

#### ORDER INFORMATION

Available in Tape and Reel

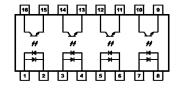
IS280GR : 3000pcs per reel IS280-4GR : 2000pcs per reel







IS280-4GR



 IS280GR
 1
 Anode / Cathode
 3
 Emitter

 2
 Cathode / Anode
 4
 Collector

 IS280-4GR
 1, 3, 5, 7
 Anode / Cathode
 9, 11, 13, 15
 Emitter

2, 4, 6, 8 Cathode / Anode 10, 12, 14, 16 Collector

#### ABSOLUTE MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Stresses exceeding the absolute maximum ratings can cause permanent damage to the device.

Exposure to absolute maximum ratings for long periods of time can adversely affect reliability.

#### Input

Forward Current ±50mA Power dissipation 65mW

#### Output

IS280-4GR 100mW

#### **Total Package**

Isolation Voltage 3750V<sub>RMS</sub>
Total Power Dissipation IS280GR 200mW

IS280-4GR 170mW

Operating Temperature -55 to 110 °C
Storage Temperature -55 to 150 °C
Lead Soldering Temperature (10s) 260°C

#### **ISOCOM COMPONENTS 2004 LTD**

Unit 25B, Park View Road West, Park View Industrial Estate Hartlepool, Cleveland, TS25 1PE, United Kingdom Tel: +44 (0)1429 863 609 Fax: +44 (0)1429 863 581 e-mail: sales@isocom.co.uk

http://www.isocom.com

#### ISOCOM COMPONENTS ASIA LTD

Hong Kong Office
Block A, 8/F, Wah Hing Industrial Mansions
36 Tai Yau Street, San Po Kong, Kowloon, Hong Kong
Tel: +852 2995 9217 Fax: +852 8161 6292
e-mail: sales@isocom.com.hk



# **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise specified)

## **INPUT**

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward Voltage	$V_{\mathrm{F}}$	$I_F = \pm 20 \text{mA}$		1.2	1.4	V
Terminal Capacitance	$C_{IN}$	V = 0V, $f = 1KHz$		60		pF

## **OUTPUT**

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector-Emitter Breakdown Voltage	BV <sub>CEO</sub>	$I_C = 0.1 \text{mA}, I_F = 0 \text{ mA}$	80			V
Emitter-Collector Breakdown Voltage	BV <sub>ECO</sub>	$I_E = 10 \mu A, I_F = 0 mA$	7			V
Collector-Emitter Dark Current	$I_{CEO}$	$V_{CE} = 20V, I_F = 0mA$			100	nA

## **COUPLED**

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Current transfer ratio	CTR	$I_F = \pm 1 \text{mA}, V_{CE} = 5 \text{V}$	100		300	%
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	$I_F = \pm 8mA, I_C = 2.4mA$			0.4	V
Floating Capacitance	$C_{\mathrm{f}}$	$V_F = 0V$ , $f = 1MHz$		0.8	1	pF
Output Rise Time	$t_{\rm r}$	$V_{CE} = 2V$ $Ic = \pm 2mA$		3	18	μs
Output Fall Time	$t_{ m f}$	$R_L = 100\Omega$		4	18	

#### **ISOLATION**

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Isolation Voltage	$V_{\rm ISO}$	R.H. = 40% to 60%, t = 1 min Note 1	3750			$V_{RMS}$
Input - Output Resistance	R <sub>I-O</sub>	$V_{I-O} = 500 VDC$ R.H. = 40% to 60% Note 1	5x10 <sup>10</sup>	1x10 <sup>11</sup>		Ω

Note 1 : Measured with input leads shorted together and output leads shorted together.



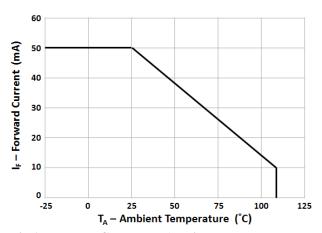


Fig 1 Forward Current vs Ambient Temperature

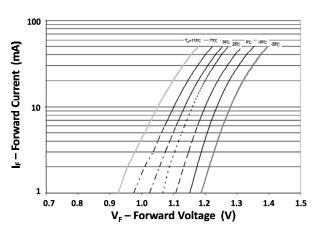


Fig 3 Forward Current vs Forward Voltage

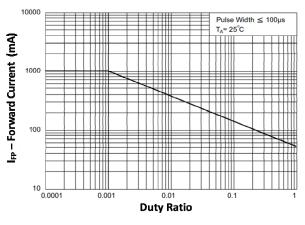


Fig 5 Pulsed Forward Current vs Duty Ratio

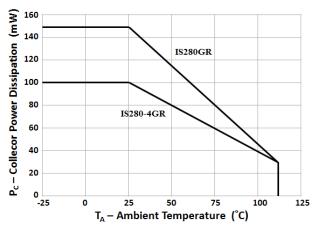


Fig 2 Output Power Dissipation vs Ambient Temperature

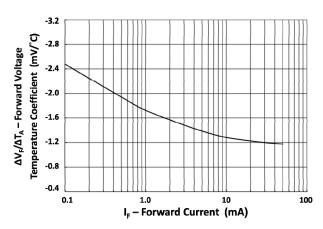


Fig 4 Forward Voltage Temperature Coefficient vs Forward Current

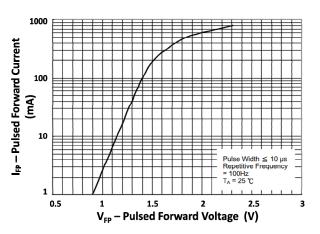


Fig 6 Pulsed Forward Current vs Pulsed Forward Voltage



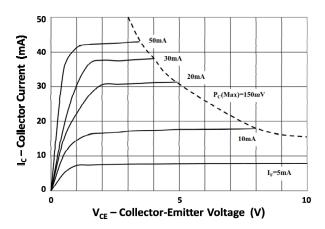


Fig 7 Collector Current vs Collector-Emitter Voltage (1)

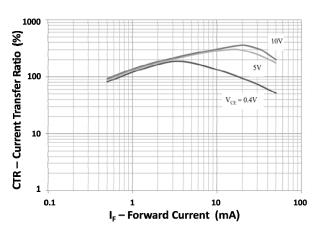


Fig 9 Current Transfer Ratio vs Forward Current

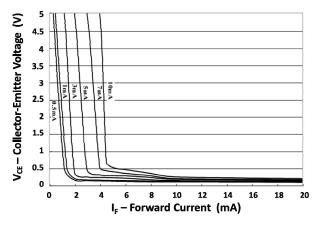


Fig 11 Collector-Emitter Voltage vs Forward Current

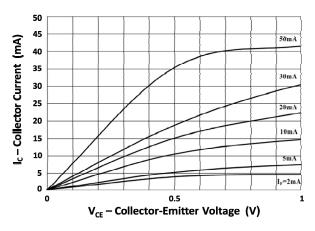


Fig 8 Collector Current vs Collector-Emitter Voltage (2)

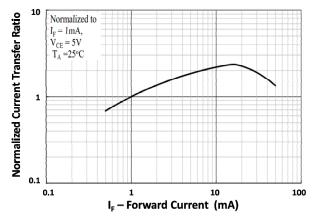


Fig 10 Normalized Current Transfer Ratio vs Forward Current

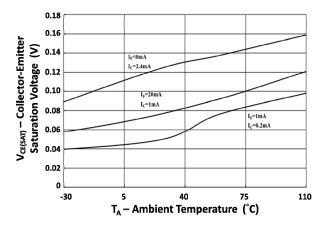


Fig 12 Collector-Emitter Saturation Voltage vs Ambient Temperature



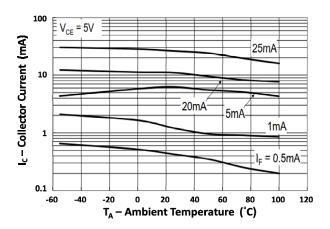


Fig 13 Collector Current vs Ambient Temperature

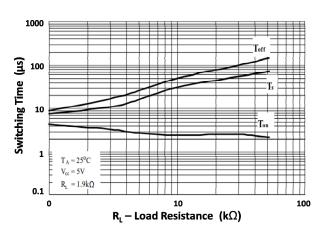


Fig 15 Switching Time vs Load Resistance

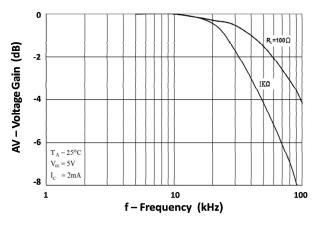


Fig 17 Frequency Response

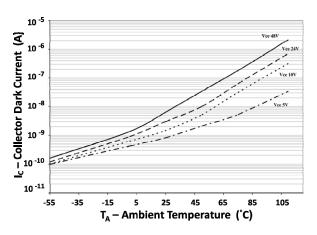


Fig 14 Collector Dark Current vs Ambient Temperature

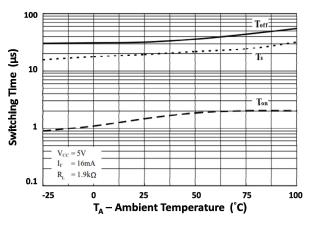
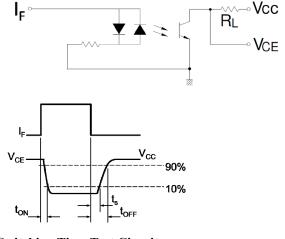


Fig 16 Switching Time vs Ambient Temperature



**Switching Time Test Circuit** 

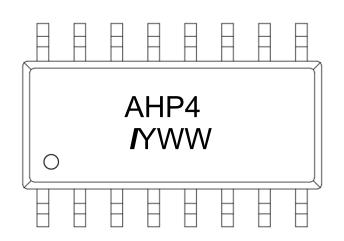


## **ORDER INFORMATION**

IS280GR, IS280-4GR				
After PN	PN	Description	Packing quantity	
CTR Grade	IS280GR	Surface Mount Tape & Reel	3000 pcs per reel	
CTR Grade	IS280-4GR	Surface Mount Tape & Reel	2000 pcs per reel	

## **DEVICE MARKING**





AHP1 denotes IS280GR

AHP4 denotes IS280GR-4

I denotes Isocom

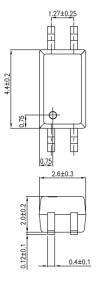
Y denotes 1 digit Year code

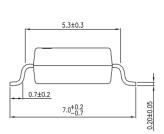
WW denotes 2 digit Week code



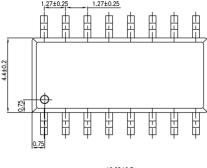
# **PACKAGE DIMENSIONS (mm)**

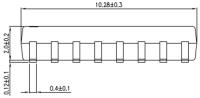
## IS280GR

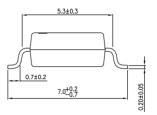




#### IS280-4GR



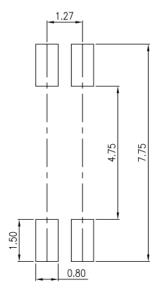




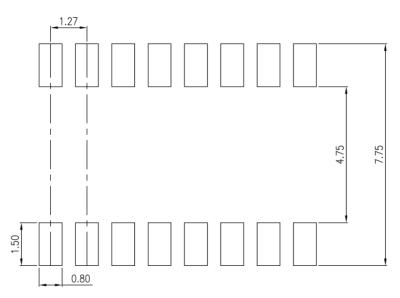


## **RECOMMENDED SOLDER PAD LAYOUT (mm)**

## IS280GR



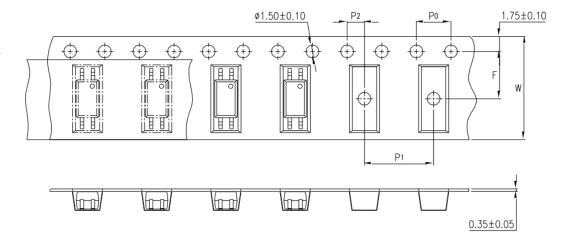
#### IS280-4GR





## **TAPE AND REEL PACKAGING**

#### IS280GR

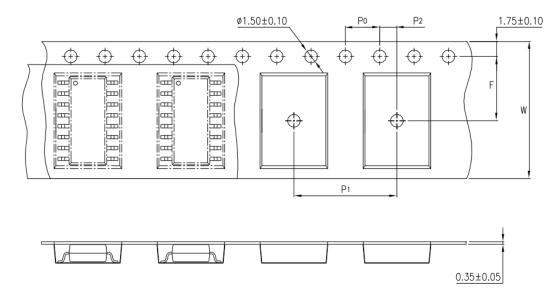


Description	Dimension	mm (inch)
Tape Width	W	12 ± 0.3 (0.47)
Pitch of Sprocket Holes	P0	4 ± 0.1 (0.15)
D: 4	F	5.5 ± 0.1 (0.217)
Distance of Compartment	P2	2 ± 0.1 (0.79)
Distance of Compartment to Compartment	P1	8 ± 0.1 (0.315)



## **TAPE AND REEL PACKAGING**

## IS280-4GR

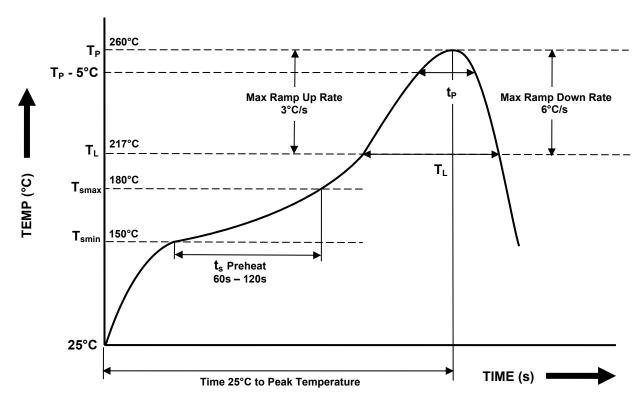


Description	Dimension	mm (inch)
Tape Width	W	16 ± 0.3 (0.63)
Pitch of Sprocket Holes	P0	4 ± 0.1 (0.15)
B: 4	F	7.5 ± 0.1 (0.295)
Distance of Compartment	P2	2 ± 0.1 (0.79)
Distance of Compartment to Compartment	P1	12 ± 0.1 (0.472)



## IR REFLOW SOLDERING TEMPERATURE PROFILE

One Time Reflow Soldering is Recommended. Do not immerse device body in solder paste.



Profile Details	Conditions
Preheat - Min Temperature (T <sub>SMIN</sub> ) - Max Temperature (T <sub>SMAX</sub> ) - Time T <sub>SMIN</sub> to T <sub>SMAX</sub> (t <sub>s</sub> )	150°C 180°C 60s - 120s
$ \begin{array}{l} \textbf{Soldering Zone} \\ - \text{ Peak Temperature } (T_P) \\ - \text{ Liquidous Temperature } (T_L) \\ - \text{ Time within 5°C of Actual Peak Temperature } (T_P - 5°C) \\ - \text{ Time maintained above } T_L \ (t_L) \\ - \text{ Ramp Up Rate } (T_L \text{ to } T_P) \\ - \text{ Ramp Down Rate } (T_P \text{ to } T_L) \\ \end{array} $	260°C 217°C 20s 60s 3°C/s max 3 - 6°C/s
Average Ramp Up Rate (T <sub>smax</sub> to T <sub>P</sub> )	3°C/s max
Time 25°C to Peak Temperature	8 minutes max



## **DISCLAIMER**

Isocom Components is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing Isocom Components products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such Isocom Components products could cause loss of human life, bodily injury or damage to property.

In developing your designs, please ensure that Isocom Components products are used within specified operating ranges as set forth in the most recent Isocom Components products specifications.

The Isocom Components products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These Isocom Components products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation Instruments, traffic signal instruments, combustion control instruments, medical Instruments, all types of safety devices, etc... Unintended Usage of Isocom Components products listed in this document shall be made at the customer's own risk.

Gallium arsenide (GaAs) is a substance used in the products described in this document. GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them. When disposing of the products, follow the appropriate regulations. Do not dispose of the products with other industrial waste or with domestic garbage.

The products described in this document are subject to the foreign exchange and foreign trade laws.

The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by Isocom Components for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of Isocom Components or others.

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Photodiode Output Optocouplers category:

Click to view products by Isocom manufacturer:

Other Similar products are found below:

TLP590B(C,F) TLP7820(A-LF4.E(O LTV-244-GB-G LTV2301GB-V-G EL816S1(C)(TU) EL817S1(C)(TU)-VG GX357NC PC817B

PC817C LTV-341W-TA1-H LTV-176G LTV-1003-TP1-G LTV-247-G-RT PC817B-MS FOC-817C-F CYPS2501-1(K)

CYTLP2362(TPD2) OR-3H7C-TP-G-(GK) ORPC-817MC-F ORPC-817D-C ORPC-817SB-TP-F PS2801C-4-F3-A/M PC817B

TLP183(YH-TPL,E(T TLP183(GRH-TPL,E(T TLP183(TPL,E(T TLP291(BL-TP,SE(T TLP184(V4GBTL,SE(T TLP785(BLL-TP6,F(C TLP293(GRH-TPL,E(T TLP383(D4GL-TR,E TLP185(BLL-TL,SE(T TLP2309(TPL,E(O TLP785(BL-TP6,F(C TLP185(GRL-TL,SE(T TLP785(GR-TP6,F(C TLP183(BL-TPL,E(T TLP2398(TPL,E(T TLP127GB-S LTV-354T-A(UMW) 6N136S(UMW) PC817B-S FOC-817C

EL1018 IS121A IS3H7A IS121D IS2701-1C IS121GB IS2701-1BL